ES2DAF

Surface Mount Ultrafast Rectifier

Features

- Fast Switching Speed – Maximum T_{rr} 35 ns
- Ultra Thin Profile – Maximum Height of 1.0 mm
- Glass Passivated Junction
- UL Flammability 94V–0 Classification
- MSL 1
- Green Mold Compound
- These Devices are Pb–Free, Halogen Free Free and are RoHS Compliant

Specifications

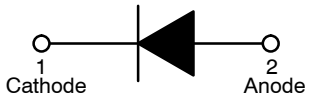
ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

Symbol	Parameter	Value	Unit
V_{RRM}	Recurrent Peak Reverse Voltage	200	V
V_{RMS}	RMS Reverse Voltage	140	V
V_R	DC Blocking Voltage	200	V
$I_{F(AV)}$	Average Forward Current	2	A
I_{FSM}	Peak Forward Surge Current: 8.3 ms Single Half Sine–Wave Superimposed on Rated Load (JEDEC Method)	50	A
T_J	Operating Junction Temperature Range	–55 to +150	°C
T_{STG}	Storage Temperature Range	–55 to +150	°C

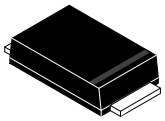
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

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Ultrafast Rectifier



DO–214AD
(SMAF)
CASE 403AD

MARKING DIAGRAM



Band Indicates Cathode

$Y	= ON Semiconductor Logo
&Z	= Assembly Plant Code
&3	= Data Code (Year & Week)
ES2DAF	= Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

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THERMAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Symbol	Characteristic	Value	Unit
Ψ_{JL}	Typical Thermal Characteristics, Junction−to−Lead (Note 1)	25	°C/W
$R_{\theta JA}$	Typical Thermal Resistance, Junction−to−Ambient (Note 2)	150	°C/W

1. Mounted on an FR4 PCB, single−sided copper, with 100 cm^2 copper pad area.
2. Mounted on an FR4 PCB, single−sided copper, mini pad.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_F	Forward Voltage	I_F = 2.0 A	−	−	0.95	V
I_R	Reverse Current	V_R = 200 V	−	−	1	μA
t_{rr}	Reverse Recovery Time	I_F = 0.5 A, I_R = 1.0 A, I_{rr} = 0.25 A	−	−	35	ns
C_J	Junction Capacitance	V_R = 4 V, f = 1 MHz	−	30	−	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ORDERING INFORMATION

Part Number	Top Mark	Package	Shipping†
ES2DAF	ES2DAF	DO−214AD (SMAF) (Pb−Free/Halogen Free)	10000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

TYPICAL PERFORMANCE CHARACTERISTICS

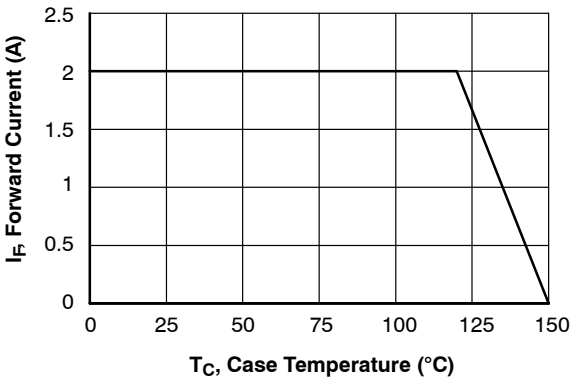


Figure 1. Forward Current Derating Curve

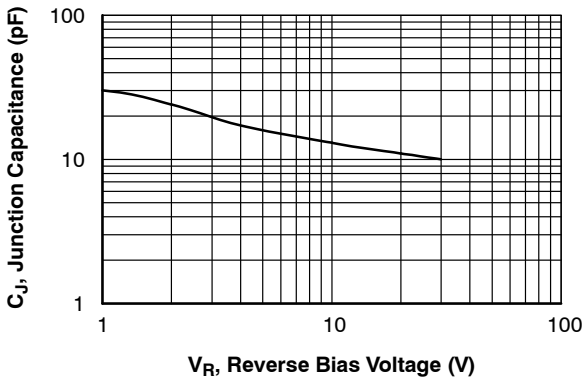


Figure 2. Typical Junction Capacitance

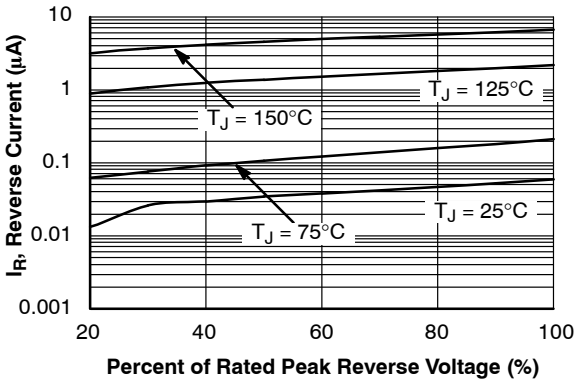


Figure 3. Typical Reverse Characteristics

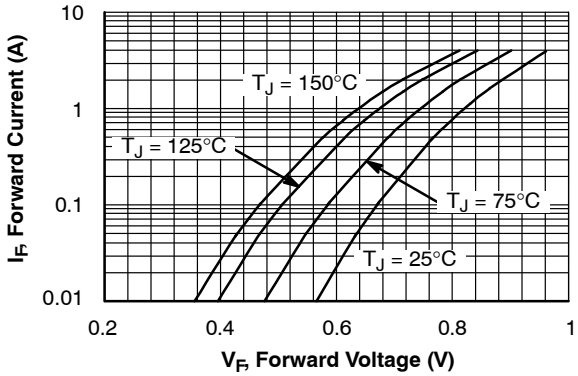
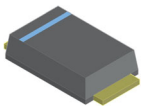


Figure 4. Typical Forward Characteristics

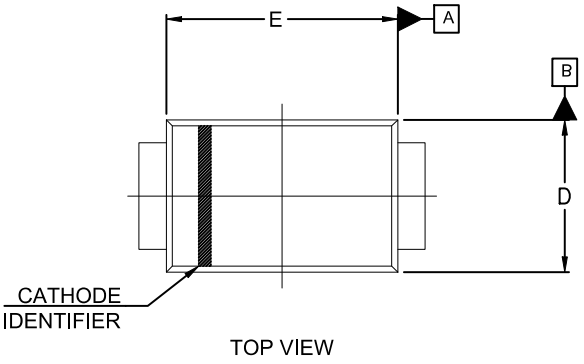
MECHANICAL CASE OUTLINE
PACKAGE DIMENSIONS

ON Semiconductor®

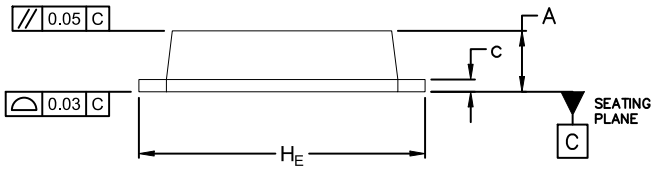


SMA−FL
CASE 403AD
ISSUE A

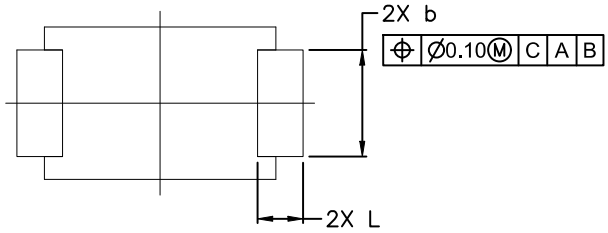
DATE 14 JUL 2020



TOP VIEW



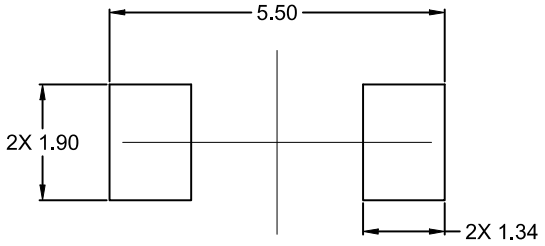
SIDE VIEW



BOTTOM VIEW

NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSIONS D & E ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR EXTRUSIONS.

DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	0.90	1.00	1.10
b	1.25	1.60	1.90
c	0.10	—	0.25
D	2.30	2.50	2.70
E	3.60	3.95	4.30
H_E	4.40	4.80	5.20
L	0.50	0.75	0.95



RECOMMENDED
MOUNTING FOOTPRINT*

* For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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